



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Jau-Yuen SU et al. Confirmation No: 5130  
Appl. No. : 09/394,918  
Filed : September 13, 1999  
Title : Substrate Sawing Process For A Strip

TC/A.U. : 3724  
Examiner : Omar Flores Sanchez

Docket No.: SUJA3001/REF  
Customer No: 23364

**AMENDMENT**

**Mail Stop AF**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action of March 20, 2006, in connection with the above-identified application. This response is timely filed.

Please amend the application as follows:

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.